

Specifications:

- 1. Polyimide base film coating with high temperature Silicone adhesive;
- 2. High temperature and corrosion resistance;
- 3. Strong adhesion;
- 4. Soft and proper and no residue after peeling off.
- 5. For electronic manufacturing industry.

Backing	Polyimide								
Adhesive type	Silicone								
Backing Thickness(mm)	0.02	0.025	0.025	0.025	0.05	0.05	0.075	0.1	0.125
Adhesive thickness(mm)	0.025	0.025	0.035	0.045	0.03	0.05	0.045	0.05	0.055
Total Thickness(mm)	0.045	0.05	0.06	0.07	0.08	0.1	0.12	0.15	0.18
Color	amber								
Adhesive strength(kg/25mm)	0.5~0.6	0.6 ~0.7	0.6~0.7	0.6~0.7	0.6~0.7	0.6~0.7	0.6~0.7	0.6~0.7	0.6~0.7
Elongation (%)	14	14	14	14	26	26	40	68	85
Corrosion resistance	1	1	1	1	1	1	1	1	1
Heat resistance(°C)	258°C								
Length(m)	50	50	33	50	33	33	33	33	33